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PATENT

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Fee Authorization
7-16-01
RATING

U.S. Express Mail Label No. ET220251476US Docket No. PAT004



NEW APPLICATION TRANSMITTAL

Transmitted herewith for filing is the patent application of Wen-Yen Hwang for his invention entitled Alternative Substrates for Epitaxial Growth.

- 1. Papers enclosed which are required for filing date under 37 CFR 1.53(b):
 - 20 Pages of specification
 - 06 Pages of claims
 - 01 Pages of abstract
 - O5 Sheets of informal drawings
- 2. Enclosed are the following documents filed in connection with this application:

Nonpublication Request Under 35 U.S.C. 122(b)(2)(B)(i); Combined Declaration and Power of Attorney; Assignment and Assignment Recordation Cover Sheet; Information Disclosure Citation; Information Disclosure Statement (PTO-1449); Cited References; and Return Postcard.

- 3. Applicant claims small entity status under 37 CFR 1.27.
- 4. The application is in the English language.

CERTIFICATE OF MAILING UNDER 37 C.F.R. § 1.10

Signature

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4. The fee calculation for a regular application is as follows:

CLAIMS AS FILED

	Number Filed			·	Number Extra		Rate		Basic Fee (37 C.F.R. 1.16(a) \$ 355.00
Total Claims	38	-	20	=	18	х	\$9	=	162.00
Independent Claims	6	-	3	=	3	х	\$40	=	120.00
Multiple Dependent Claims (if any)						+	\$270		
Total Filing Fee .								\$ 637.00	

- 5. The Commissioner is hereby authorized to charge Deposit Account No. 50-1705 in the amount of \$677.00 to cover fees associated with this application (\$637 for filing fees and \$40 for assignment recordation fee).
- 6. The Commissioner is hereby authorized to charge the following additional fees by this paper and during the entire pendency of this application to Deposit Account No. 50-1705.

37 CFR 1.16 (filing fees)

37 CFR 1.16 (presentation of extra claims)

37 CFR 1.16(e) (surcharge for filing the basic filing fee and/or declaration on a date later than the filing date of the application).

37 CFR 1.17 (application processing fees)

7. Any overpayment is to be credited to Account No. 50-1705.

Respectfully submitted,

328-01

N. Stephan Kinsella

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PTO/SB/35 (11-00)

Approved for use through 10/31/2002. OMB 0651-0031 U.S. Patent and Trademark Office; U. S. DEPARTMENT OF COMMERCE

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NONPUBLICATION REQUEST UNDER 35 U.S.C. 122(b)(2)(B)(i)

First Named Inventor		Wen-Yen Hwang				
Title	Alternative S	ative Substrates for Epitaxial Growth				
Atty Do	ocket Number	PAT004				

I hereby certify that the invention disclosed in the attached application has not and will not be the subject of an application filed in another country, or under a multilateral agreement, that requires publication at eighteen months after filing.

I hereby request that the attached application not be published under 35 U.S.C. 122(b).

March 28, 2001 Date

N. Stephan Kinsella

Typed or printed name

This request must be signed in compliance with 37 CFR 1.33(b) and submitted with the application **upon filing**.

Applicant may rescind this nonpublication request at any time. If applicant rescinds a request that an application not be published under 35 U.S.C. 122(b), the application will be scheduled for publication at eighteen months from the earliest claimed filing date for which a benefit is claimed.

If applicant subsequently files an application directed to the invention disclosed in the attached application in another country, or under a multilateral international agreement, that requires publication of applications eighteen months after filing, the applicant must notify the United States Patent and Trademark Office of such filing within forty-five (45) days after the date of the filing of such foreign or international application. Failure to do so will result in abandonment of this application (35 U.S.C. 122(b)(2)(B)(iii)).